

Conference Calendar

February 1989

- 13-17 **Plasma Processing in Semiconductor Materials**
Bristol (United Kingdom)
Contact: Dr. S. Pringle, Dept. of Extramural Studies, The Univ., Queens Rd., Bristol BS8 1HR, UK
- 15-17 **Solid-State Circuits,**
36th IEEE Int. Conf.
New York (USA)
Contact: L. Winner, 301 Almeria Ave., Coral Gables, FL 33134, USA
- 19-22 **Adhesion,**
12th. Annu. Mtg.
Hilton Head Island (USA)
Contact: D. Hunston, NBS, Polym. Div., Gaithersburg, MD 20899, USA
- 21-24 **Recent Advances in Drug Delivery**
Salt Lake City (USA)
Contact: K. Knutson, Univ. of Utah, Dept. of Pharmaceuticals, CCCD, 421 Wakara Way, Suite 318, Salt Lake City, UT 84108, USA
- 21-26 **Optical Fibers and their Applications,**
5th Symp.
Warsaw (Poland)
Contact: R. S. Romaniuk, IPI Warsaw Univ. of Technol., Nowowiejska 15-19, PL-00-665, Warsaw, Poland
- 26-3 **Microlithography,**
Symp. and Exhibition (Micro '89)
Santa Clara (USA)
Contact: Soc. of Photo-Optical Instrumentation Eng. (SPIE), P.O. Box 10, Bellingham, WA 98227, USA
- 27-1 **Microphysics of Surfaces, Beams and Adsorbates,**
3rd Top. Mtg.
Salt Lake City (USA)
Contact: R. B. Hall, Exxon Research & Eng., Rt. 22E, Annandale, NJ 08801, USA

- 27-3 **Superconductivity,**
Gordon Conf.
West Coast (USA)
Contact: A. Sleight, E.I. Du Pont de Nemours, Experimental Station 356/301, Wilmington, DE 19898, USA
- 27-3 **High-Temperature Superconducting Oxides: Processing & Related Properties,**
TMS Annu. Mtg.
Las Vegas (USA)
Contact: The Metallurgical Soc., 420 Commonwealth Dr., Warrendale, PA 15086, USA

March 1989

- 1-3 **Technical Ceramics,**
2nd Int. Congr. and Exhibit. (Techkeram 2)
Wiesbaden (Fed. Rep. Germany)
Contact: Demat Exposition Managing, P.O. Box 110611, D-6000 Frankfurt, FRG
- 5-10 **Liquid Crystals,**
6th Eur. Winter Conf.
Schladming (Austria)
Contact: P. Laggner, Inst. für Röntgenfeinstrukturforschung of the Austrian Acad. of Sci., Steyrergasse 17, A-8010 Graz, Austria
- 6-8 **Crystal Structure, Microstructure and Properties of Minerals and Ceramic Materials,**
Int. Colloq.
Bochum (Fed. Rep. Germany)
Contact: Prof. O. W. Flörke, Ruhr-Univ. Bochum, Inst. für Mineralogie, P.O. Box 102148, D-4630 Bochum, FRG
- 6-8 **Lithium Battery Technology & Applications,**
4th Int. Seminar
Deerfield Beach (USA)
Contact: S. P. Wolsky, Ansum Enterprises Inc., 950 De Soto Rd., Suite 3B, Boca Raton, FL 33432, USA

- 6-9 **Advanced Materials**
MRS Industry-Univ. Conf.
Denver (USA)
Contact: Dr. Fred Smith, Adv. Mater. Inst., Colorado School of Mines, 1500 Illinois, Golden, CO 80401, USA
- 6-9 **Condensed Matter Division,**
Eur. Phys. Soc.,
9th Gen. Conf.
Nice (France)
Contact: J. P. Latteuorte, Lab. de la Metiere Condensee, Univ. de Nice, F-06034 Nice, Cedex, France
- 6-10 **Quantum Wells for Optics and Optoelectronics; Picosecond Electronics and Optoelectronics,**
Top. Mtg.
Salt Lake City (USA)
Contact: Optical Soc. of America (OSA), 1816 Jefferson Pl. NW, Washington, DC 20036, USA
- 8-9 **Molecular Chemistry of Solid-State Electronics**
London (United Kingdom)
Contact: The Royal Society, 6 Carlton House Terrace, London SW1Y 5AG, UK
- 9-10 **The Martensitic Transformation in Science and Technology**
Bochum (Fed. Rep. Germany)
Contact: Dtsch. Ges. Metallkd., Adenauerallee 21, D-6370 Oberursel FRG
- 9-11 **Makromolekulares Kolloquium**
Freiburg (Fed. Rep. Germany)
Contact: Prof. H. Finkelmann, Inst. für Makromol. Chemie der Univ., Stefan-Meier-Str. 31, D-7800 Freiburg, FRG
- 11-14 **Surface Finishing '89**
Brighton (United Kingdom)
Contact: Inst. of Metal Finishing, Exeter House, 48 Holloway Head, Birmingham B1 1NQ, UK
- 12-14 **High-Tech-Materials and Finishing**
Berlin (West)
Contact: Technik + Kommunikation-Verlag GmbH, Ritterfelddamm 82 h + i, D-1000 Berlin 22

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| <p>12-25 Diffusion in Materials, NATO Adv. Study Inst. Aussois (France)
Contact: A. L. Laskar, Phys. and Astron. Dept., Clemson Univ., Clemson, SC 29631, USA</p> <p>13-14 Regio Macro II Basel (Switzerland)
Contact: Prof. M. Mutter, Inst. für Org. Chem., Univ. Basel, St. Johannis-Ring 19, CH-4056 Basel, Switzerland</p> <p>15-17 Confocal Microscopy/3-D Image Processing in Microscopy, 1st Int. Conf./2nd Int. Conf. Amsterdam (Netherlands)
Contact: Bureau PAOG, Congr. Office, Tafelbergweg 25, NL-1105 BC, Amsterdam, Netherlands</p> <p>15-17 Intelligent Materials, Int. Workshop Ibaraki (Japan)
Contact: T. Kurino, The Soc. of Nontraditional Technol., Toranomon Kotohira-Kaikan Bldg. 3F, 1-2-8 Toranomon, Minato-ku, Tokyo 105, Japan</p> <p>20-22 Mechanical Properties of Materials at High Rates of Strain, 4th Int. Conf. Oxford (United Kingdom)
Contact: J. Harding, Eng. Sci. Dept., Univ. of Oxford, Parks Rd., Oxford OX1 3PJ, UK</p> <p>20-22 Refractory Metals and Silicides Eur. Workshop Houthalen (Belgium)
Contact: R. De Keersmaecker, IMBE, Kapeldreef 75, B-3030 Leuven, Belgium</p> <p>20-23 Surface Science, Interdisciplinary Conf. Liverpool (United Kingdom)
Contact: P. Weightman, Liverpool Univ., Oliver Lodge Lab., Oxford St., P.O. Box 147, Liverpool L69 3BX, UK</p> <p>27-31 Aerospace Sensing, Tech. SPIE's Symp. Orlando (USA)
Contact: Soc. of Photo-Optical Instrumentation Eng. (SPIE), Technical Program Committee, P.O. Box 10, Bellingham, WA 98227, USA</p> | <p>28-31 Aluminum-Lithium 5th Int. Conf. Williamsburg (USA)
Contact: Al-Li-V, School of Eng. and Applied Sci., Thornton Hall, Univ. of Virginia, Charlottesville, VA 22901, USA</p> <p>29-31 Neutron and X-Ray Scattering: Complementary Techniques Canterbury (United Kingdom)
Contact: Dr. R. J. Newport, Univ. of Kent, Physics Dept., Canterbury, Kent CT2 7NR, UK</p> <p>30-31 Colorado Microelectronics Colorado Springs (USA)
Contact: CMC '89 Conf. Secretary, Microelectronics Research Lab., Univ. of Colorado, Colorado Springs, CO 80933-7150, USA</p> <p>30-14 High-T_c Superconductors, Exp. Workshop Miramare (Italy)
Contact: Int. Ctr. for Theoretical Physics, P.O. Box 586, I-34100 Trieste, Italy</p> | <p>3-7 High Temperature Materials '89 Gaithersburg (USA)
Contact: J. W. Hastie, National Bureau of Standards, Gaithersburg, MD 20899, USA</p> <p>4-7 Electrochemical Processing of Semiconductors Berlin (West)
Contact: W. Pieth, Free Univ. of Berlin, Inst. of Phys. Chem., Takustraße 3, D-1000 Berlin 33</p> <p>4-14 Phase Transition in Soft Condensed Matter, NATO Adv. Study Inst. Geilo (Norwegen)
Contact: G. Jarret, Inst. for Energy Technol., Dept. of Physics, P.O. Box 40, N-2007 Kjeller, Norwegen</p> <p>6-7 Modeling in Crystal Growth from the Melt, NATO Workshop Parma (Italy)
Contact: G. Müller, Inst. für Werkstoffwissenschaften 6, Martensstraße 7, D-8520 Erlangen, FRG</p> |
| <p>April 1989</p> | | |
| <p>20-22 Refractory Metals and Silicides Eur. Workshop Houthalen (Belgium)
Contact: R. De Keersmaecker, IMBE, Kapeldreef 75, B-3030 Leuven, Belgium</p> <p>20-23 Surface Science, Interdisciplinary Conf. Liverpool (United Kingdom)
Contact: P. Weightman, Liverpool Univ., Oliver Lodge Lab., Oxford St., P.O. Box 147, Liverpool L69 3BX, UK</p> <p>27-31 Aerospace Sensing, Tech. SPIE's Symp. Orlando (USA)
Contact: Soc. of Photo-Optical Instrumentation Eng. (SPIE), Technical Program Committee, P.O. Box 10, Bellingham, WA 98227, USA</p> | <p>1-6 Superconductivity, 2nd World Congr. Houston (USA)
Contact: R. D. Kane, World Congr. on Superconductivity, P.O. Box 27805, Houston, TX 77227-7805, USA</p> <p>3-5 Modern Practice in Stress and Vibration Analysis Liverpool (United Kingdom)
Contact: Meetings Officer, Inst. of Physics, 47 Belgrave Sq., London SW1X 8QX, UK</p> <p>3-6 Low Energy Ion Beams, 5th Conf. Guildford (United Kingdom)
Contact: Meetings Officer, Inst. of Physics, 47 Belgrave Sq., London SW1X 8QX, UK</p> <p>3-7 Copolymerization and Copolymers in Dispersed Media Lyon (France)
Contact: I. Guillot/C. Pichot, Lab. des Matériaux Organiques, BP 24, F-69390 Vernaion, France</p> | <p>10-12 Bayreuther Polymer Symp., Bayreuth (Fed. Rep. Germany)
Contact: BPS '89, Lehrstuhl Makromolekulare Chemie II, Univ. Bayreuth, Postfach 101251, D-8580 Bayreuth, FRG</p> <p>10-13 Microscopy of Semiconducting Materials, MRS 6th Oxford Conf. Oxford (United Kingdom)
Contact: Administrator, Royal Microscopy Soc., 37/38 St. Clements, Oxford OX4 1AJ, UK</p> <p>11-13 Catalysis by Well Characterized Materials Liverpool (United Kingdom)
Contact: Prof. R. W. Joyner, Leverhulme Ctr. for Innovative Catalysts, Univ. of Liverpool, Grove St., P.O. Box 147, Liverpool L69 3BX, UK</p> <p>17-26 Ceramics and Composite Materials, Spring College in Mater. Sci. Trieste (Italy)</p> |

- Contact: Int. Ctr. for Theoretical Physics, Spring College in Mater. Sci. 1989, P.O. Box 586, I-34100 Trieste, Italy
- 18-19 **Industrial Water-Soluble and Water-Swellable Polymers**
Manchester (United Kingdom)
Contact: The Registrar (Mid-Career Training), UMIST, P.O. Box 88, Manchester M60 1QD, UK
- 23-28 **Nondestructive Testing**, 12th World Conf. (WCNDT '89)
Amsterdam (Netherlands)
Contact: B. de Jong, RAI Organisatie Bureau Amsterdam bv, Europaplein 12, 1078 GZ Amsterdam, Netherlands
- 23-27 **American Ceramic Society**, 91st Annu. Mtg. and Expo.
Indianapolis (USA)
Contact: Dr. K. M. Nair, Electronics Dept., E.I. du Pont de Nemours Co., Inc., 3181 Buffalo Ave., Niagara Falls, NY 14302, USA
- 24-28 **Optical Science and Engineering**, 2nd Int. Congr.
Paris (France)
Contact: Soc. of Photo-Optical Instrumentation Eng. (SPIE), P.O. Box 10, Bellingham, WA 98227, USA
- 24-28 **Lasers and Electro-Optics**, LEOS-IEEE-OSA Conf. (CLEO '89)
Baltimore (USA)
Contact: Optical Soc. of America (OSA), 1816 Jefferson Pl. NW, Washington, DC 20036, USA
- 24-28 **MRS Spring Mtg.**
San Diego (USA)
Contact: J. B. Ballance, MRS, 9800 McKnight Rd., Suite 327, Pittsburgh, PA 15237, USA
- 25-27 **Hot Isostatic Pressing of Materials**
Antwerpen (Belgium)
Contact: Hot Isostatic Pressing Conf., c/o K. VIV, Jan van Rijswijklaan 58, B-2018 Antwerpen, Belgium
- 26-28 **Joining Ceramics, Glass and Metal**
3rd Int. Conf. (CGM '89)
Contact: Dtsch. Gesellsch. Metallkd., Adenauerallee 21, D-6370 Oberursel, FRG
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- May 1989**
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- 1-3 **Tunable Solid State Lasers**, Top. Mtg.
North Falmouth (USA)
Contact: Optical Soc. of America (OSA), 1816 Jefferson Pl. NW, Washington, DC 20036, USA
- 1-5 **Scanning Microscopy**, Salt Lake City (USA)
Contact: O. Johari, Scanning Microscopy Int., P.O. Box 66507, Chicago, IL 60666, USA
- 4-6 **The Solid State—Dynamics and Kinetics**
Annu. Mtg. Dtsch. Bunsen-Gesellsch. für Phys. Chem. Siegen (Fed. Rep. Germany)
Contact: Dtsch. Bunsen-Gesellsch., Carl-Bosch-Haus, Varrentrappstr. 40/42, D-6000 Frankfurt am Main 90, FRG
- 7-12 **High- T_c Superconductor Technologies**
175th Mtg. Electrochem. Soc. Los Angeles (USA)
Contact: S. Raider, IBM T. J. Watson Research Ctr., P.O. Box 218, York Town Heights, NY 10598, USA
- 7-12 **Fundamentals of Adsorption**, 3rd Int. Conf.
Nurrigen (Fed. Rep. Germany)
Contact: DECHEMA, Abt. Tagungen, P.O. Box 970146, Theodor Heuss-Allee 25, D-6000 Frankfurt am Main 97, FRG
- 8-12 **High Temperature and Wear Resistant Materials in a World of Changing Technology**
12th Int. Plansee Seminar
Plansee (Austria)
Contact: Metallwerk Plansee, A-6600 Reutte, Austria
- 9-11 **Coatings and Sensors for Acoustic and Electromagnetic-Optical Applications**
Univ. Park. (USA)
Contact: V. K. Varadan, Dept. of Eng. Sci. and Mechanics, Penn. State Univ., 227 Hammond Bldg., Univ. Park, PA 16802, USA
- 10-11 **Polyimides**
Montpellier (France)
Contact: Prof. M. Abadie, LEMD/MAO-USTL, F-34060 Montpellier Cedex 1, France
- 16-19 **Modern Developments in Materials Science and Technology**, Annu. Mtg. Dtsch. Gesellsch. Metallkd. Karlsruhe (Fed. Rep. Germany)
Contact: Dtsch. Gesellsch. Metallkd., Adenauerallee 21, D-6370 Oberursel, FRG
- 22-24 **Werkstoffanalytik**, Wien (Austria)
Contact: Prof. Dr. M. Grasserbauer, Inst. für Analytische Chem. der Tech. Univ. Wien, Getreidemarkt 9, A-1060 Wien, Austria
- 22-24 **Glastechnische Tagung**
Stuttgart (Fed. Rep. Germany)
Contact: Dtsch. Glastechn. Gesellsch., Mendelssohnstr. 75-77, D-6000 Frankfurt am Main, FRG
- 22-25 **Clustering and Aggregated State of Matter**
Strasbourg (France)
Contact: Prof. E. Constantin, Groupe de Recherche de Spectrométrie de Masse Interlab., Dept. de Chim., 1 rue Blaise Pascal, 67008 Strasbourg Cedex, France
- 22-25 **Graphite Intercalation Compounds**, 5th Int. Symp. (ISGIC-5)
Berlin (West)
Contact: Dr. F. W. Froben, Fachbereich Physik, Freie Univ. Berlin, Arnimallee 14, D-1000 Berlin 33
- 24-26 **Advances in the Stabilization and Controlled Degradation of Polymers**, 11th Int. Conf.
Luzern (Switzerland)

- Contact: Dr. A. V. Patsis, Inst. in Materials Sci, State Univ. of New York, New Paltz, NY 12561, USA
- 25-26 **Quantitative Methods in Assessment of Structural Defects**
Kansas City (USA)
Contact: A. P. Berens, Univ. of Dayton, Research Inst., 300 College Park Ave., Dayton, OH 45469, USA
- 29-31 **Cross-linked Polymers**, 3rd Int. Conf.
Luzern (Switzerland)
Contact: Dr. A. V. Patsis, Inst. in Materials Sci, State Univ. of New York, New Paltz, NY 12561, USA
- 29-2 **Molecular Beams**
Perugia (Italy)
Contact: V. Aquilanti, Univ. di Perugia, Dipt. di Chimica, I-06100 Perugia, Italy
- 30-2 **E-MRS Spring Mtg.**
Strasbourg (France)
Contact: P. Siffert, Ctr. de Recherches Nucléaire, Lab. PHASE, F-67037 Strasbourg, Cedex, France
- 31-2 **Applied Surface Analysis**, 11th Symp.
Cleveland (USA)
Contact: J. Grant, Research Inst., 300 College Park, Dayton, OH 45469-0001, USA
- 31-2 **Thermogravimetry and Thermal Engineering**, 6th Biennial Conf.
Budapest (Hungary)
Contact: I. Benko, MATE, House of Technol. III. 318, P.O. Box 451, H-1372 Budapest, Hungary
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- June 1989**
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- 6-9 **Chemistry of Functional Dyes**, Int. Symp. (ESTech '89)
Osaka (Japan)
Contact: Prof. T. Kitao, General Secretary of the Symp., Kinki Chem. Soc., Japan 1-8-4, Utsubo honmachi, Nishi-ku, Osaka 550, Japan
- 12-14 **Rubber**, Int. Conf. 90 IRC Exhibition
Paris (France)
Contact: Soc. de Chimie Industrielle, 28, rue Saint-Dominique, F-75007 Paris, France
- 12-15 **Narrow-Gap Semiconductors and Related Materials**, Int. Conf.
Ogunquit (USA)
Contact: D. G. Seiler, Phys. Dept., Univ. of North Texas, P.O. Box 5368, Denton, TX 76203, USA
- 18-21 **Colloid & Surface Science**, 63rd ACS Div. of Colloid & Surface Chem. Symp.
Seattle (USA)
Contact: J. Berg, Dept. of Chemical Eng. BF-10, Univ. of Washington, Seattle, WA 98105, USA
- 19-21 **Composites**
Asia-Pacific 89
Adelaide (Australia)
Contact: The Secretariat, Techsearch, Composites Asia-Pacific '89, P.O. Box 2471, Adelaide S.A. 5001, Australia
- 19-21 **SAMPE-Electronics**, 3rd Int. Conf.
Los Angeles (USA)
Contact: M. Smith, Business Director, SAMPE, P.O. Box 2459, Covina, CA 91722, USA
- 21-23 **Chemically Modified Surfaces**, Midland (USA)
Contact: W. T. Collins, Dow Corning Corp., Mail Stop C41C00, Midland, MI 48686, USA
- 21-23 **Electronic Materials**
Cambridge (USA)
Contact: The Metallurgical Soc., 420 Commonwealth Dr., Warrendale, PA 15086, USA
- 22-25 **Optics Asia '89**
Singapore (Singapore)
Contact: Asia '89, 994 Bendemeer Rd., N° 04-03, Singapore 1233, Singapore
- 25-30 **Solid State Sensors and Actuators (Transducers-5)/ Eurosensors III**
Montreux (Switzerland)
Contact: COMST S.A., P.O. Box 415, CH-1001 Lausanne I, Switzerland
- 26-28 **Molecular Design of Functional Polymers**, IUPAC Int. Symp.
Seoul (Korea)
Contact: IUPAC Int. Symp., c/o Polymer Soc. of Korea, Rm. 601, Hyecheon Bldg., 831 Yeoksam-dong, Kangnam-ku, Seoul 135-792, Korea
- 26-30 **Solid State Chemistry**, 2nd Int. Symp.
Pardubice (Czechoslovakia)
Contact: Dr. L. Koudelka, Inst. of Chem. Technol., Leninovo nam., 565, CS-53210 Pardubice, Czechoslovakia
- 26-30 **Supermembranes**
Trieste (Italy)
Contact: Int. Ctr. for Theoretical Physics, P.O. Box 586, I-34100 Trieste, Italy
- 27-28 **Polymer Latex III**
London (United Kingdom)
Contact: Miss M. Peacock, Plastics and Rubber Inst., 11 Hobart Place, London SW1W 0HL, UK
- 28-30 **Oxide Surfaces**
Midland (USA)
Contact: W. T. Collins, Mail Stop C41C00, Dow Corning Corp., Midland, MI 48686-0994, USA
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- July 1989**
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- 2-7 **Solid State Organic Materials**, 9th Int. Conf.
Como (Italy)
Contact: Centro di Cultura Scientifica, "A. Volta", Villa Olmo, Via Cantoni 1, I-22100 Como, Italy
- 3-6 **Conduction and Breakdown in Solid Dielectrics**
3rd Int. Conf. (ICSD '89)
Trondheim (Norway)
Contact: Prof. Sletbak, ICSD '89, The Norwegian Inst. of Technol., Sem Sælunds V 13, N-7034 Trondheim, Norway
- 3-28 **Liquids, Freezing and the Glass Transition**
NATO Adv. Study Inst.
Les Houches (France)

- Contact: École d'Été de Physique Théorique, F-74310 Les Houches, France
- 4-7 **Nonlinear and Electro-optics**
Int. Conf.
Cambridge (United Kingdom)
Contact: The Meetings Officer,
The Inst. of Physics,
47 Belgrave Square,
London SW1X 8QX, UK
- 9-14 **Scanning Tunneling Microscopy/Spectroscopy**,
4th Int. Conf.
Oarai (Japan)
Contact: O. Nishikawa, The
Graduate School of Nagatsuta,
Tokyo Inst. of Technol., 4259
Nagatsuta, Midori-ku,
Yokohama 227, Japan
- 9-14 **Zeolites**,
8th Int. Conf.
Amsterdam (Netherlands)
Contact: M. Laboushere,
792 Keizersgracht, 1017 EC,
Amsterdam, The Netherlands
- 10-12 **Applied Organometallic Chemistry: an Entry to the New Technology**
The Pines Resort (Australia)
Contact: Dr. A. F. Masters,
School of Chemistry, Univ.
of Sydney, Sydney, N. S. W.
2006, Australia
- 10-13 **Magnetic Resonance in Polymers**,
9th Spec. Colloq. Ámpere
Prague (Czechoslovakia)
Contact: P. M. M. Secretariat,
c/o. Inst. of Macromol.
Chem., Czech. Acad. of Sci.,
16206 Prague, Czechoslovakia
- 10-14 **Electron Spectroscopy**,
4th Int. Conf.
Honolulu (USA)
Contact: G. E. McGuire, Mi-
croelectronics Ctr. of North
Carolina, P.O. Box 12889,
Research Triangle Park,
NC 27709, USA
- 10-14 **Organic Coatings Science and Technology**,
15th Int. Conf.
Athens (Greece)
Contact: Dr. A. V. Patsis,
Inst. in Materials Sci, State
Univ. of New York, New
Paltz, NY 12561, USA
- 11-14 **Numerical Analysis of Semiconductor Devices and Integrated Circuits**,
6th Int. Conf.
Dublin (Ireland)
Contact: J. J. H. Miller, Nase-
Code Conf., INCA, P.O. Box
2, Dún Laoghaire, Ireland
- 12-14 **Solid-State Laser/Optical Fiber Science and Electro-magnetic Theory '89**,
Top. Mtg./Sino-Japanese
Joint Mtg.
Beijing (Peoples' Rep. China)
Contact: Optical Soc. of Amer-
ica (OSA), 1816 Jefferson Pl.
NW, Washington, DC 20036,
USA
- 16-21 **Catalysis**,
Eur. Conf.
Berlin (West)
Contact: Prof. G. Ertl, Fritz-
Haber-Inst. der Max-Planck-
Gesellschaft., Faradayweg 4-6,
D-1000 Berlin
- 17-20 **Polymer Blends**
Prague (Czechoslovakia)
Contact: P. M. M. Secretariat,
c/o. Inst. of Macromol.
Chem., Czech. Acad. of Sci.,
16206 Prague, Czechoslovakia
- 18-20 **Polymer Chemistry: Aspects of Radical Polymerization**
Lancaster (United Kingdom)
Contact: Dr. J. R. Ebdon,
Dept. of Chemistry,
Univ. of Lancaster,
Lancaster LA1 4YA, UK
- 18-21 **Integrated Optics and Optical Fiber Communications**,
7th Int. Conf. (IOOC-7)
Kobe (Japan)
Contact: P. W. Shumate, Jr.,
Bell Communications
Research, 435 S St., Morris-
town, NJ 07960, USA
- 23-28 **Materials and Mechanisms of Superconductivity: High-Temperature Superconductors**,
Int. Conf. (HTSC-M²S)
Stanford (USA)
Contact: Dr. T. H. Geballe,
Dept. of Applied Phys., Stan-
ford Univ., Stanford, CA
94305, USA
- 24-26 **Micro-Optics/Gradient-Index Optical Imaging Systems**,
2nd Conf./8th Top. Mtg.
Tokyo (Japan)
Contact: K. Iga, Tokyo Inst.
of Technol., Research Lab.
of Precision Machinery and
Electronics, 4259 Nagatsuta,
Midori-ku, Yokohama 227,
Japan
- 24-26 **Composite Structures**,
5th Int. Conf.
Paisley (United Kingdom)
Contact: Dr. I. H. Marshall,
Dept. of Mechanical and Pro-
duction Eng., Paisley College
of Technol., High St., Paisley
PA 12BE, UK
- 31-2 **Biologically-Engineered Polymers**
Cambridge (United Kingdom)
Contact: Royal Soc. of Chem-
istry, Burlington House,
London W1V 0BN, UK

August 1989

- 2-7 **Pure and Applied Chemistry**,
32nd IUPAC Congr.
Stockholm (Sweden)
Contact: Stockholm Conven-
tion Bureau, P.O. Box 6911,
S-10239 Stockholm, Sweden
- 13-26 **High-T_c Superconductors**,
NATO Adv. Study Inst.
Bad Windsheim (Fed. Rep.
Germany)
Contact: R. Kossowsky, Ap-
plied Res. Lab., Pennsylvania
State Univ., P.O. Box 30,
State College, PA 16804, USA
- 14-17 **Shock Compression of Condensed Matter**,
APS Top. Conf.
Albuquerque (USA)
Contact: A. Roach, MS-P 915,
Los Alamos Nat. Lab., Los
Alamos, NM 87545, USA
- 14-18 **Hopping Transport**,
8th Conf.
Chapel Hill (USA)
Contact: M. Pollak, Dept. of
Phys., Univ. of California,
Riverside, CA 92521, USA
- 20-24 **Imaging Systems - 150 Years of Photography**,
Int. Symp. (ISIS '89)
Dresden (German Dem. Rep.)

Contact: Conf. Secretary,
ISIS '89, Technische Univ.
Dresden, Sektion Physik, Wis-
senchaftsbereich Photophysik,
Mommensenstr. 13, DDR-8027
Dresden, GDR

- 20-25 **Crystal Growth: Progress in
Science and Technology,**
9th Int. Conf.
Sendai (Japan)
Contact: Prof. T. Nishinaga,
Inter Group Corp., Akasaka
Yamakatsu Bldg., 8-5-32,
Akasaka Minato-ku, Tokyo
107, Japan

- 21-24 **Amorphous and Liquid
Semiconductors,**
13th Int. Conf.
Asheville (USA)
Contact: D. E. Sayers, P.O.
Box 8202, North Carolina
State Univ., Raleigh, NC
27695-8202, USA

- 21-26 **Photochemistry,**
Int. Conf.
Beijin (People's Rep. China)
Contact: Prof. S. Wu, Inst.
of Photographic Chem., Acad-
emia Sinica, Beijing, People's
Rep. China

- 28-31 **Dynamical Processes in Excited
States of Solids,**
7th Int. Conf. (DPC '89)
Athens (USA)
Contact: DPC '89, Prof. J. E.
Rives, Dept. of Physics and
Astronomy, Univ. of Georgia,
Athens, GA 30602, USA

- 28-I **Ferroelectricity,**
7th Int. Mtg. (IMF-7)
Saarbrücken (Fed. Rep.
Germany)
Contact: Dr. J. Albers, Univ.
des Saarlandes, Fachbereich
Physik, D-6600 Saarbrücken,
FRG

- 28-1 **Sintering,**
7th World Round Table Conf.
Herceg-Novi (Yugoslavia)
Contact: Dr. D. P. Uskoković,
Serbian Academy of Sci. and
Arts, Knez-Mihailova 35,
11000 Beograd, Yugoslavia

- 28-1 **X-Ray Optics and
Microanalysis,**
12th Int. Congr.

Cracow (Poland)
Contact: S. Jasienska, Acad-
emy of Mining and Metallur-
gy,
Inst. of Metallurgy,
30-059 Cracow, Poland

- 28-2 **Photochemistry for
High Technology,**
Int. Summer School
Leuna-Merseburg (German
Dem. Rep.)
Contact: Prof. H.-J. Timpe,

Sektion Chemie, Technische
Hochschule für Chemie,
Leuna-Merseburg, Gensaeistr.,
DDR-42 Merseburg, GDR

- 29-2 **Innovation and Perspectives
in Solid Phase Synthesis,**
Int. Symp.
Oxford (United Kingdom)
Contact: R. Epton, School of
Appl. Sci., Wolverhampton
Polytech., Wolverhampton
WV1 1SB, UK

Materials Related Gordon Research Conferences

General Information

Contact: Dr. A. M. Cruickshank, Director, Gordon Research Conf.,
Gordon Res. Ctr., Univ. of Rhode Island, Kingston, RI 02881-0801, USA
Locations: Colby-Sawyer College (N), (S): New London, NH;
New Hampton School: New Hampton, NH;
Kimball Union Academy: Meriden, NH
Tilton School: Tilton, NH

June 1989

- 19-23 **Catalysis**
Colby-Sawyer College (N)
Chairman: L. D. Schmidt
26-30 **Polymers**
Colby-Sawyer College (N)
Chairman: J. P. Kennedy

- 17-21 **Corrosion**
Colby-Sawyer College (N)
Chairman: H. J. Grabke

- 17-21 **Chemistry at Interfaces**
Kimball Union Academy
Chairman: R. Johnson

- 17-21 **Superconducting Films**
Tilton School
Chairman: D. Gubser

- 31-4 **Ion-Containing Polymers**
Colby-Sawyer College (S)
Chairman: G. Wilkes

July 1989

- 3-7 **Fiber Science**
Colby-Sawyer College (N)
Chairman: B. C. Goswami
3-7 **Thermosetting Polymers**
Colby-Sawyer College (S)
Chairman: N. J. Johnston
10-14 **Elastomers**
Colby-Sawyer College (N)
Chairman: G. Ver Strate
10-14 **Metal Hydrides**
Tilton School
Chairman: F. D. Manchester

August 1989

- 7-11 **Physical Metallurgy**
Tilton School
Chairman: J. C. Williams
14-18 **Studies in Solid-State Ceramics**
Colby-Sawyer College
Chairman: U. Chowdhry
14-18 **Science of Adhesion**
New Hampton School
Chairman: R. A. Pike